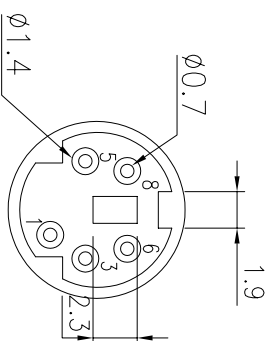


PCB LAYOUT
(BOTTOM VIEW)



HOW TO ORDER

MDX-XX-X
 — Type No.
 — No. of Contact
 □: Normal Part
 G: ROHS Part
 V: For Lead Free process
 Base No.

NO.	NAME	MATERIAL	FINISH	Q'TY	REMARK
(4)	BACK COVER	THERMOPLASTIC	BLACK	1	
(3)	SHIELD	COPPER ALLOY	TIN PLATED	1	NI:40-60u" ; TIN PLATED:100-120u"
(2)	CONTACT	PHOS. BRONZE	GOLD-TIN PLATED	5	NI:40-60u" ; TIN PLATED:100-120u" GOLD:1-3u"
(1)	HOUSING	THERMOPLASTIC	BLACK	1	

LONG CHU ELECTRONICS CO. LTD
龍竹企業股份有限公司

DESCRIPTION

MINI DIN JACK

MATERIAL

SEE NOTE

UNIT

mm

GENERAL TOLERANCE

0. ±.50
 0.0 ±.30
 0.00 ±.20

SIZE

A4

P/N

MD-05-A

SCALE

REV.

A

DATE

08/02/04*

DR.

KELLY

RE.

APP.

CHK.

DESCRIPTION

RELEASED

REV.
